



Product Change Notification

Change Notification #: 117427 - 00
Change Title: Intel® Axxia™ GUERTRINITYSB0,
GUERTRINITYTB0, GUERTRINITYUB0,
PCN 117427-00, Manufacturing Site,
Adding Additional Manufacturing Site in
Penang Malaysia (PGAT)
Date of Publication: February 14, 2020

Key Characteristics of the Change:

Manufacturing Site

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 13, 2020
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Description of Change to the Customer:

Intel is qualifying an additional Manufacturing Site in Penang Malaysia (PGAT) to perform full flow manufacturing (Assembly, Test, and Finish) on the products listed in the Products Affected / Intel Ordering Codes table below.

Products could then be manufactured among the two qualified sites, China CDAT) and/or Penang Malaysia (PGAT) where both the Penang Malaysia Manufacturing Site and the China Manufacturing Sites will be certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Customers could notice a change of the value printed on outer shipping box labels representing the Country of Origin, depending on the site that manufactured the products.

Example only (Penang Malaysia as Country of Origin)



Example only (China as Country of Origin)

(P) CUST PROD:	(1B) BOX: RLX00035
(V) SUPPLIER: 04195 INTEL	MAX REFLOW 260 °C TEMP
(1P) IPN: INTEL PRODUCT NAMEXX	LEVEL 3 HOURS 168
(S) SPEC: S 1234 (30P) MM#: 123456	BAG SEAL DATE 03JUN14
(1T) LOT: FPO NUMBER	(Q) QTY: 12345 (9D) DATE: YYWW
(1T) LOT:	(Q) QTY:
(9D) DATE:	

RoHS COMPLIANT: e1

ASSEMBLED IN CHINA

Customer Impact of Change and Recommended Action:

There is no change to the form, fit, functionality, quality or reliability for the products. Both China site and Penang Malaysia sites will be certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Customers should notify their receiving department to expect shipments from either country of manufacturing.

Please contact your Intel Field Representative for any questions and concerns.

Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® Axxia™ GUERTRINITYSB0	B0	GUERTRINITYSB0	S LLQR	949430
Intel® Axxia™ GUERTRINITYTB0	B0	GUERTRINITYTB0	S R3TJ	961954
Intel® Axxia™ GUERTRINITYUB0	B0	GUERTRINITYUB0	S R3VV	962985

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
February 14, 2020	00	Originally Published PCN



Product Change Notification

117427 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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